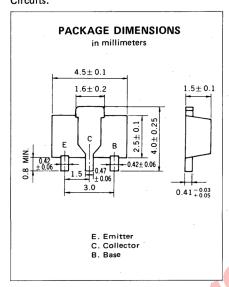


SILICON TRANSISTOR 2SD1614

NPN SILICON EPITAXIAL TRANSISTOR POWER MINI MOLD

DESCRIPTION

2SD1614 is designed for audio frequency power amplifier and switching application, especially in Hybrid Integrated Circuits.



FEATURES

- High DC Current Gain : hFE 135 to 600
- Low V_{CE (sat)} : V_{CE (sat)} = 0.2 V
- Complement to 2SB1114

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Collector to Base Voltage	V _{CBO}	40	V
Collector to Emitter Voltage	VCEO	20	V
Emitter to Base Voltage	VEBO	6.0	V
Collector Current (DC)	IC(DC)	2.0	Α
Collector Current (Pulse)*	I _C (Pulse)	3.0	Α
Total Power Dissipation **	P_{T}	2.0	W
Junction Temperature	Τj	150	°C
Storage Temperature Range	T _{stg}	-55 to +150	°C

^{*}PW ≤ 10 ms, Duty Cycle ≤ 50%

ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Collector Cutoff Current	ICBO	1		100	nA .	V _{CB} = 30 V, I _E = 0
Emitter Cutoff Current	IEBO			100	nA	V _{EB} = 6.0 V, I _C = 0
DC Current Gain	hFE1***	135	350	600		V _{CE} = 2.0 V, I _C = 100 mA
DC Current Gain	hFE2***	40	250			V _{CE} = 2.0 V, I _C = 2.0 A
Collector Saturation Voltage	VCE(sat)***		0.3	0.5	V	IC = 2.0 A, IB = 50 mA
Base Saturation Voltage	VBE(sat)***		0.95	1.2	V	IC = 2.0 A, IB = 50 mA
Base to Emitter Voltage	V _{BE} ***	650	680	750	mV	VCE = 6.0 V, IC = 100 mA
Gain Bandwidth Product	fT		200		MHz	VCE = 10 V, IE = -50 mA
Output Capacitance	C _{ob}		28		pF	V _{CB} = 10 V, I _E = 0, f = 1.0 MHz

^{***}Pulsed: PW \leq 350 μs , Duty Cycle $\leq~2~\%$

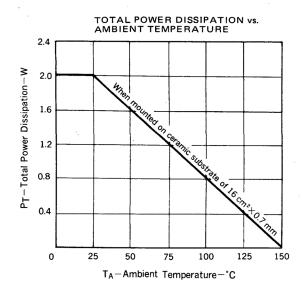
h_{FE} Classification

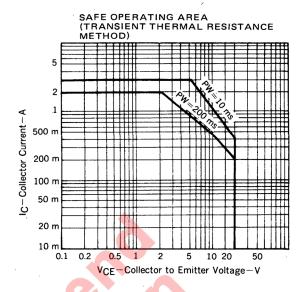
MARKING	XM	XL	ΧK
hFE1	135 to 270	200 to 400	300 to 600

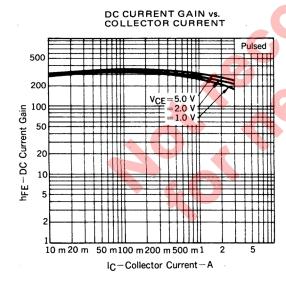
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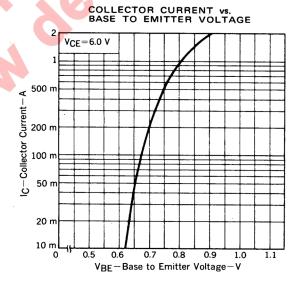
^{**}When mounted on ceramic substrate of 16 cm² x 0.7 mm

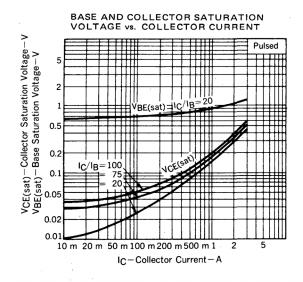
TYPICAL CHARACTERISTICS (TA = 25°C)

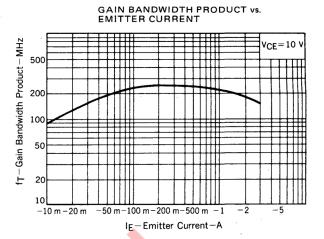


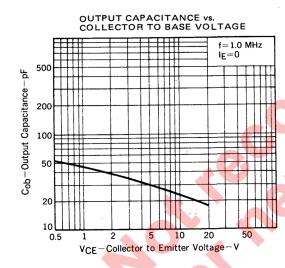












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